## **NeoSpectra-Micro**



# **Integrated Spectral Sensor**

The NeoSpectra-Micro is an integrated spectral sensor that can be used in a wide variety of material sensing applications for qualification and quantification. The sensor offers performance comparable to laboratory based spectrometers, but at a dramatically smaller size and lower cost.

The sensors are based on Fourier Transform InfraRed (FT-IR) technology, which is a standard technique that offers a wide spectral range for the best qualification and quantification of materials. The sensors used patented Micro Electro Mechanical Systems (MEMS) technology, which allows for a Michelson interferometer to be created monolithically on a MEMS chip.

## Integrated Optical Head

Optical head that with light sources for direct diffused reflectance measurements.

## **BGA Solderable**

Underside is solder bumped and is solderable to PCBs similar to a Ball Grid Array (BGA) package.

## **SPI** Communication

Control and read via Serial Peripheral Interface (SPI) communication.



## What's inside:

### **Optical Head**

o Light sources for sample illumination o Collection of diffused reflected light

### **Electronics**

- o Application Specific Integrated Circuits (ASICs) for system control and data processing
- o Proprietary design for performance optimization
- o Reduces the amount of external components

### **Optical Core Module**

o Monolithic MEMS Michelson interferometer o Single uncooled InGaAs photodector

## Features:

#### Performance

- o Wide spectral range
- Different modes to optimize power consumption
- Sensitivity optimization enabled

#### Implementation

- o Miniature
- Fully integrated
- Free-space optics
- No cooling required

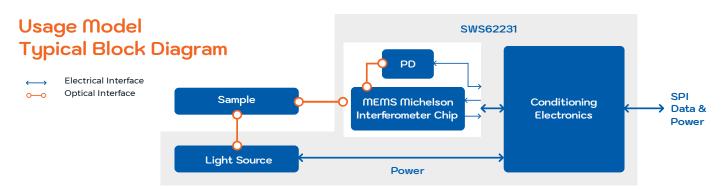
## **Economic Benefits**

- o Low cost
- Designed for high volume production
- Minimum amount of external components

# **Technical Specifications:**

Parameter	Conditions	Value	Units
Wavelength Range	PSD*> max PSD/10	1,350 - 2,500	nm
Resolution	At $\lambda$ = 1,550 nm, FWHM criterion	16	nm
Typical SNR (rms)	2s Scan time, @λ = 2,350 nm	2,000 : 1	-
Temperature	Operation	-5 : 40	°C
Wavelength Accuracy	@λ = 1,400 nm; temperature < 40° C	± 1.5	nm
Wavelength Repeatability	@λ = 1,400 nm; absorbance level= 0.5 A.U.	±0.1	nm

\*PSD: Power Spectral Density



## What's Possible

Enabling a broad range of applications and use cases across multiple industries.



**Smart Farming** 



Smart Food



Smart Healthcare



Smart Industry



## Plug-and-Play Development Kits

The NeoSpectra-Micro Development Kit (DVK) is a set of components that connect the NeoSpectra-Micro to a Raspberry Pi, which acts as a host for easy interfacing. The DVKs enable developers to evaluate the performance of the NeoSpectra-Micro and to start application and product development.

DVK includes:

- **o** NeoSpectra-Micro unit
- Raspberry Pi board
- Evaluation software
- Software Development Kit (SDK) and reference code
- Various operation modes:
- Connected to PC
- Standalone
- Component with SPI interface





www.neospectra.com info@si-ware.com

## Si-Ware Egypt

3, Khaled Ibn Al-Waleed St. Sheraton, Heliopolis Cairo 11361, Egypt + 20 222 68 47 04 Si-Ware Europe 16 Boulevard Saint-Germain Paris 75005 France + 33 1 44 07 98 51 Si-Ware USA 1150 Foothills Blvd., Suite M La Canada, CA 91011 USA + 1 818 790 1151